



**ST2318SRG** 

N Channel Enhancement Mode MOSFET

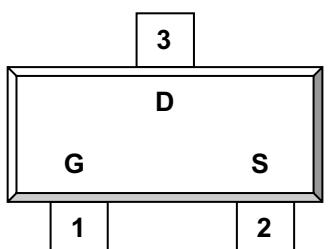
3.9A

## DESCRIPTION

ST2318SRG is the N-Channel logic enhancement mode power field effect transistor is produced using high cell density, DMOS trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management, other battery powered circuits, and low in-line power loss are needed in a very small outline surface mount package.

## PIN CONFIGURATION

### SOT-23



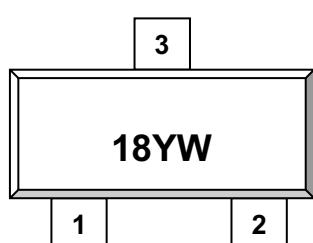
1.Gate    2.Source    3.Drain

## FEATURE

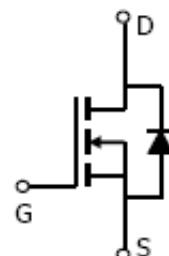
- 40V/3.9A,  $R_{DS(ON)} = 42m\Omega$  (Typ.)  
@VGS = 10V
- 40V/3.5A,  $R_{DS(ON)} = 47m\Omega$   
@VGS = 4.5V
- 40V/2.0A,  $R_{DS(ON)} = 75 m\Omega$   
@VGS = 2.5V
- Super high density cell design for extremely low  $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability
- SOT-23 package design

## PART MARKING

### SOT-23



Y: Year Code    W: Week Code



STANSON TECHNOLOGY

120 Bentley Square, Mountain View, Ca 94040 USA  
[www.stansontech.com](http://www.stansontech.com)

ST2318SRG 2009. V1



**ST2318SRG**   
N Channel Enhancement Mode MOSFET

3.9A

**ABSOLUTE MAXIMUM RATINGS** (Ta = 25°C Unless otherwise noted )

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V <sub>DSS</sub>	40	V
Gate-Source Voltage	V <sub>GSS</sub>	±12	V
Continuous Drain Current TJ=150°C)	I <sub>D</sub>	4.0 3.0	A
Pulsed Drain Current	I <sub>DM</sub>	10	A
Continuous Source Current (Diode Conduction)	I <sub>S</sub>	1.20	A
Power Dissipation	P <sub>D</sub>	1.20 0.8	W
Operation Junction Temperature	T <sub>J</sub>	150	°C
Storage Temperature Range	T <sub>STG</sub>	-55/150	°C
Thermal Resistance-Junction to Ambient	R <sub>θJA</sub>	100	°C/W



**ST2318SRG** Pb  
N Channel Enhancement Mode MOSFET

3.9A

**ELECTRICAL CHARACTERISTICS ( Ta = 25°C Unless otherwise noted )**

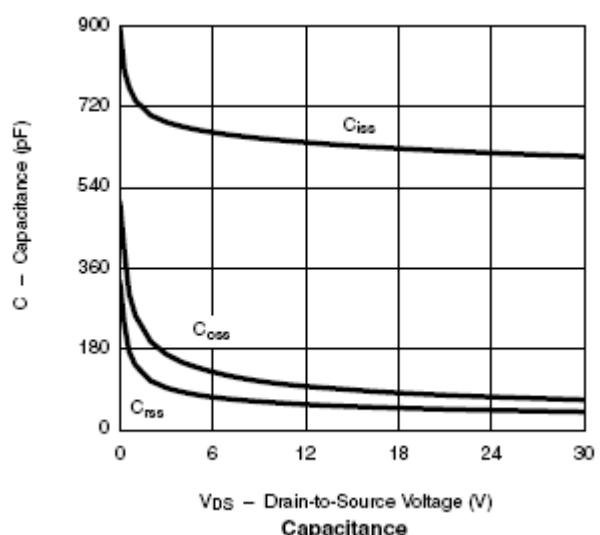
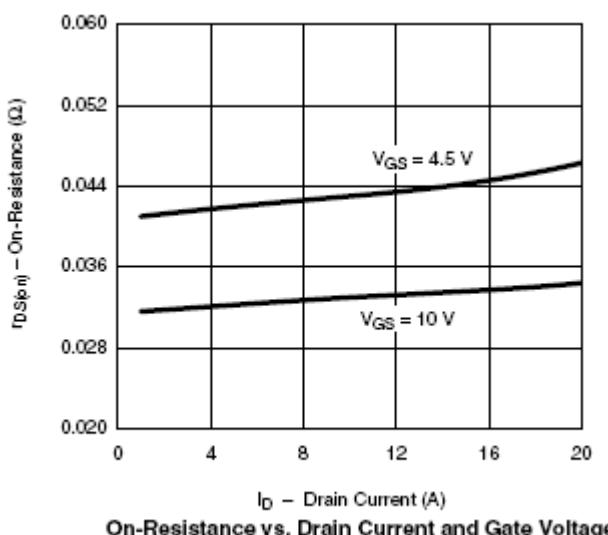
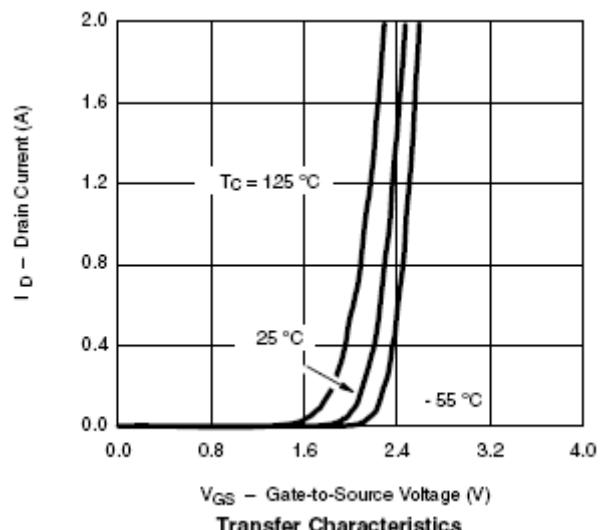
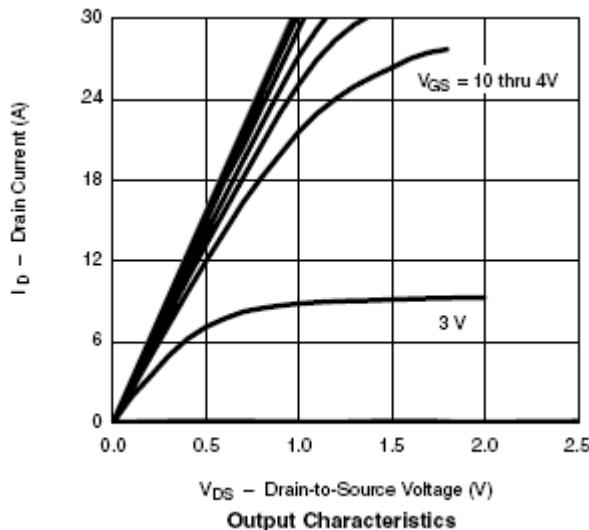
Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250uA	40			V
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250uA	0.45		1.0	V
Gate Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =±12V			±100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =40V, V <sub>GS</sub> =0V			1	uA
		V <sub>DS</sub> =40V, V <sub>GS</sub> =0V T <sub>J</sub> =85°C			5	
On-State Drain Current	I <sub>D(on)</sub>	V <sub>DS</sub> ≥5V, V <sub>GS</sub> =4.5V	10			A
Drain-source On-Resistance	R <sub>D(S)on</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =3.9A V <sub>GS</sub> =4.5V, I <sub>D</sub> =3.5A V <sub>GS</sub> =2.5V, I <sub>D</sub> =2.0A		0.042 0.053 0.075	0.047 0.060 0.085	Ω
Forward Transconductance	g <sub>fS</sub>	V <sub>DS</sub> =15V, I <sub>D</sub> =6.2A		13		S
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =2.3A, V <sub>GS</sub> =0V		0.8	1.2	V
<b>Dynamic</b>						
Total Gate Charge	Q <sub>g</sub>	V <sub>DS</sub> =15V V <sub>GS</sub> =10V I <sub>D</sub> =2.0A		16	24	nC
Gate-Source Charge	Q <sub>gs</sub>			3		
Gate-Drain Charge	Q <sub>gd</sub>			2.5		
Turn-On Time	t <sub>d(on)</sub> tr	V <sub>DD</sub> =15V R <sub>L</sub> =15Ω I <sub>D</sub> =1.0A V <sub>GEN</sub> =10V R <sub>G</sub> =6Ω		15	20	nS
Turn-Off Time	t <sub>d(off)</sub> tf			6	12	
				10	20	
				40	80	



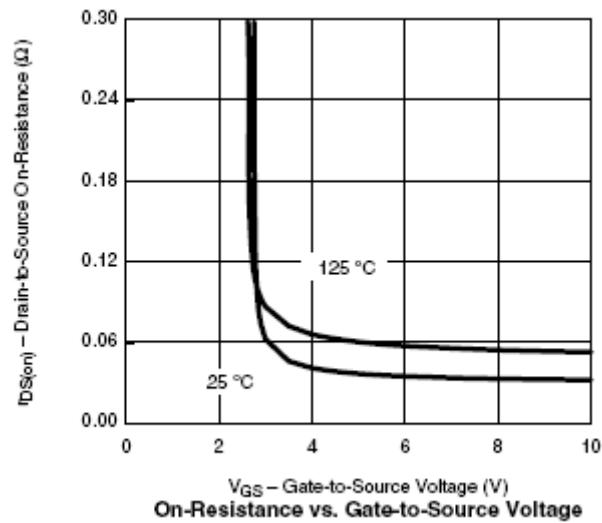
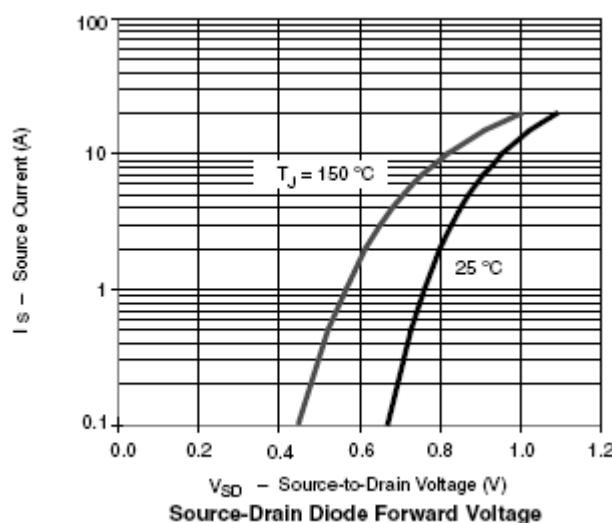
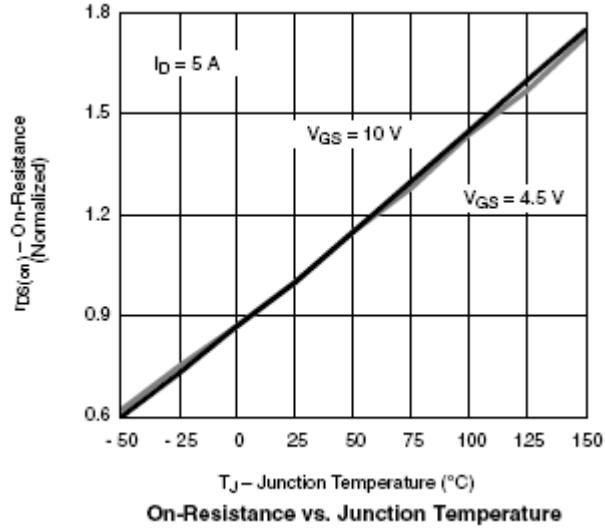
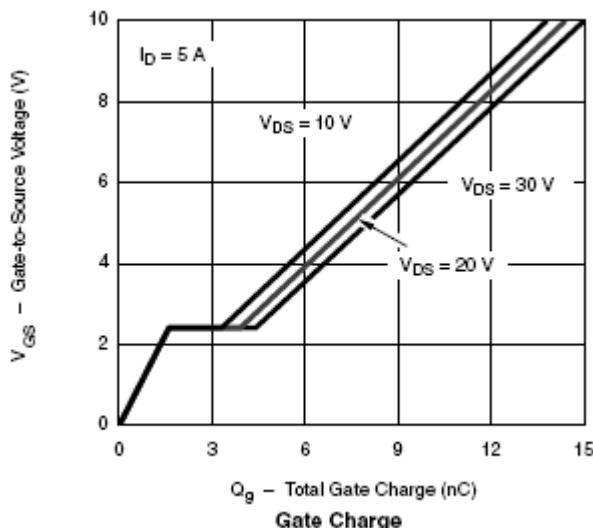
**ST2318SRG**   
N Channel Enhancement Mode MOSFET

3.9A

**TYPICAL CHARACTERISTICS** (25°C Unless noted)



**TYPICAL CHARACTERISTICS** (25°C Unless noted)

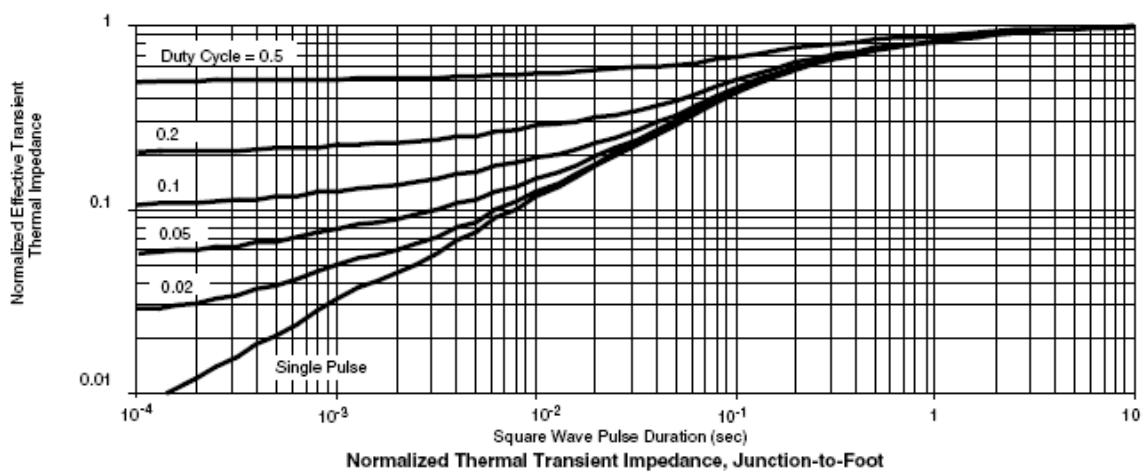
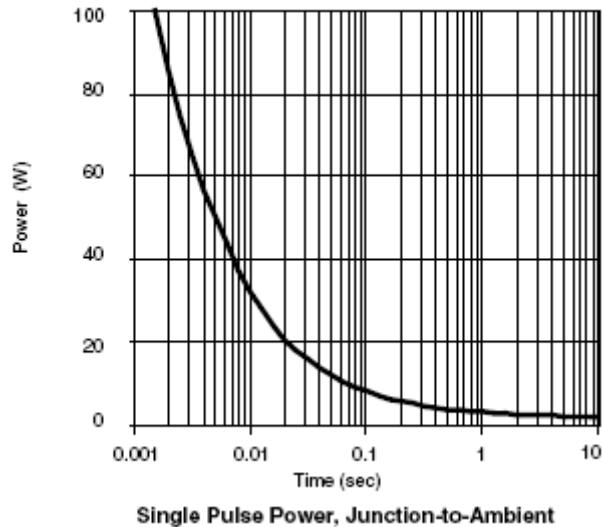
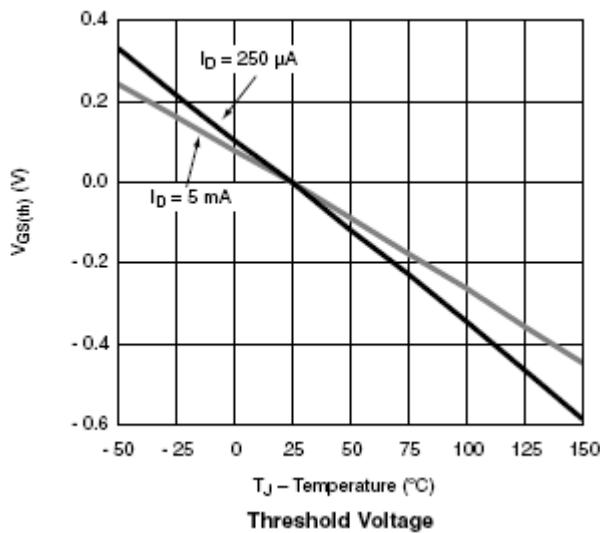




**ST2318SRG** N Channel Enhancement Mode MOSFET

3.9A

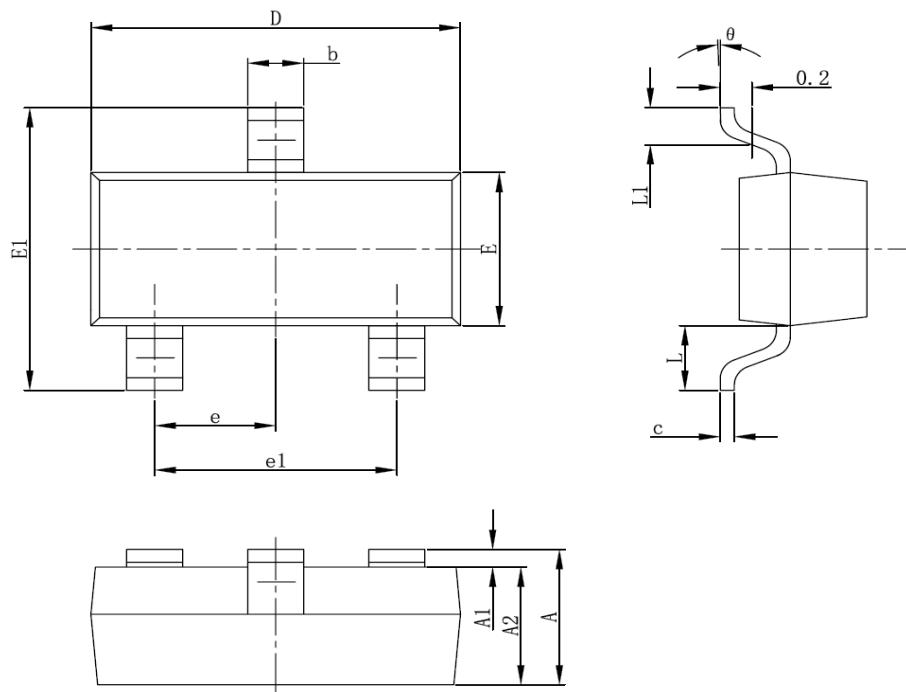
**TYPICAL CHARACTERISTICS** (25°C Unless noted)



STANSON TECHNOLOGY  
120 Bentley Square, Mountain View, Ca 94040 USA  
[www.stansontech.com](http://www.stansontech.com)

ST2318SRG 2009. V1

**SOT-23 PACKAGE OUTLINE**



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.100	0.035	0.043
A1	0.000	0.100	0.000	0.004
A2	0.900	1.000	0.035	0.039
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950TYP		0.037TYP	
e1	1.800	2.000	0.071	0.079
L	0.550REF		0.022REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°